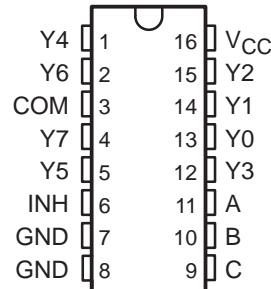


- **EPIC™ (Enhanced-Performance Implanted CMOS) Process**
- **High On-Off Output-Voltage Ratio**
- **Low Crosstalk Between Switches**
- **Individual Switch Controls**
- **Extremely Low Input Current**
- **Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II**
- **ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)**
- **Package Options Include Plastic Small-Outline (D, NS), Shrink Small-Outline (DB), Thin Very Small-Outline (DGV), Thin Shrink Small-Outline (PW), Ceramic Flat (W) Packages, and Standard Plastic (N) and Ceramic (J) DIPs**

SN54LV4051A . . . J OR W PACKAGE
SN74LV4051A . . . D, DB, DGV, N, NS, OR PW PACKAGE
(TOP VIEW)



description

These 8-channel CMOS analog multiplexers/demultiplexers are designed for 2-V to 5.5-V V_{CC} operation.

The 'LV4051A devices handle both analog and digital signals. Each channel permits signals with amplitudes up to 5.5 V (peak) to be transmitted in either direction.

Applications include signal gating, chopping, modulation or demodulation (modem), and signal multiplexing for analog-to-digital and digital-to-analog conversion systems.

The SN54LV4051A is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74LV4051A is characterized for operation from -40°C to 85°C.

FUNCTION TABLE

INPUTS				ON CHANNEL
INH	C	B	A	
L	L	L	L	Y0
L	L	L	H	Y1
L	L	H	L	Y2
L	L	H	H	Y3
L	H	L	L	Y4
L	H	L	H	Y5
L	H	H	L	Y6
L	H	H	H	Y7
H	X	X	X	None



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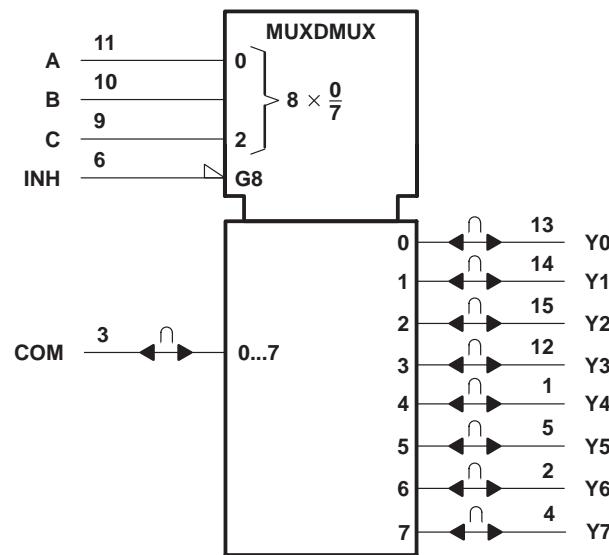


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SN54LV4051A, SN74LV4051A 8-CHANNEL ANALOG MULTIPLEXERS/DEMULITPLEXERS

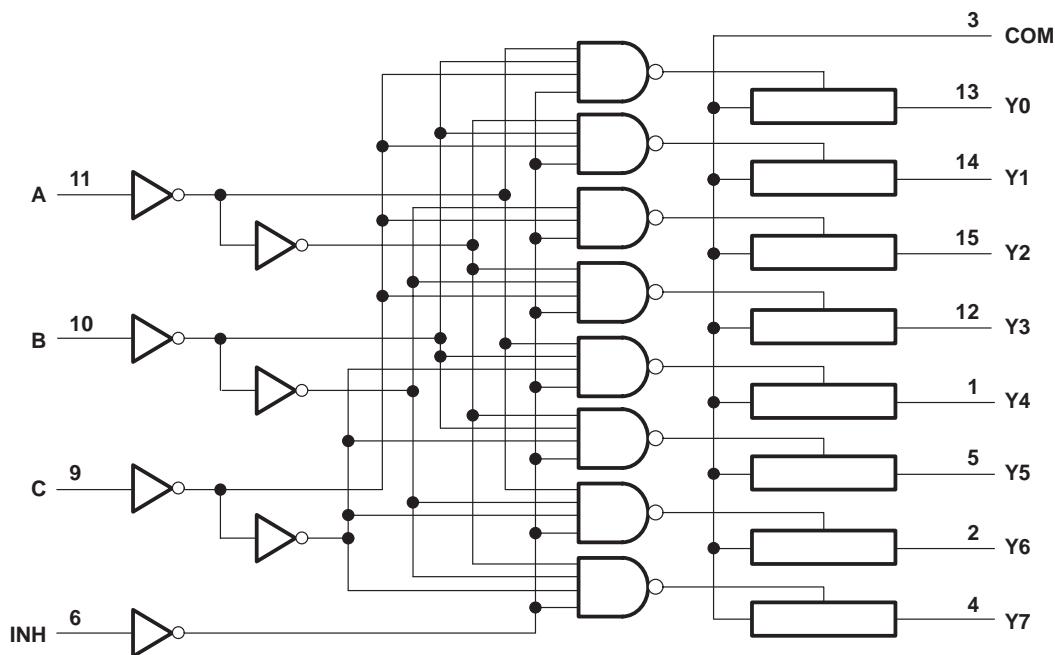
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logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC}	–0.5 V to 7.0 V
Input voltage range, V_I (see Note 1)	–0.5 V to 7.0 V
Switch I/O voltage range, V_{IO} (see Note 1 and Note 2)	–0.5 V to V_{CC} + 0.5 V
Input clamp current, I_{IK} ($V_I < 0$)	–20 mA
I/O diode current, I_{I0K} ($V_{IO} < 0$ or $V_{IO} > V_{CC}$)	±50 mA
Switch through current, I_T ($V_{IO} = 0$ to V_{CC})	±25 mA
Continuous current through V_{CC} or GND	±50 mA
Package thermal impedance, θ_{JA} (see Note 3): D package	113°C/W
DB package	131°C/W
DGV package	180°C/W
N package	78°C/W
NS package	111°C/W
PW package	149°C/W
Storage temperature range, T_{stg}	–65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. This value is limited to 7 V maximum.
3. The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.

recommended operating conditions (see Note 4)

		SN54LV4051A		SN74LV4051A		UNIT
		MIN	MAX	MIN	MAX	
V_{CC}	Supply voltage	2‡	5.5	2‡	5.5	V
V_{IH}	High-level input voltage, control inputs	$V_{CC} = 2$ V	1.5	1.5	1.5	V
		$V_{CC} = 2.3$ V to 2.7 V	$V_{CC} \times 0.7$	$V_{CC} \times 0.7$	$V_{CC} \times 0.7$	
		$V_{CC} = 3$ V to 3.6 V	$V_{CC} \times 0.7$	$V_{CC} \times 0.7$	$V_{CC} \times 0.7$	
		$V_{CC} = 4.5$ V to 5.5 V	$V_{CC} \times 0.7$	$V_{CC} \times 0.7$	$V_{CC} \times 0.7$	
V_{IL}	Low-level input voltage, control inputs	$V_{CC} = 2$ V	0.5	0.5	0.5	V
		$V_{CC} = 2.3$ V to 2.7 V	$V_{CC} \times 0.3$	$V_{CC} \times 0.3$	$V_{CC} \times 0.3$	
		$V_{CC} = 3$ V to 3.6 V	$V_{CC} \times 0.3$	$V_{CC} \times 0.3$	$V_{CC} \times 0.3$	
		$V_{CC} = 4.5$ V to 5.5 V	$V_{CC} \times 0.3$	$V_{CC} \times 0.3$	$V_{CC} \times 0.3$	
V_I	Control input voltage	0	5.5	0	5.5	V
V_{IO}	Input/output voltage	0	V_{CC}	0	V_{CC}	V
$\Delta t/\Delta V$	Input transition rise or fall rate	$V_{CC} = 2.3$ V to 2.7 V	0	200	0	200
		$V_{CC} = 3$ V to 3.6 V	0	100	0	100
		$V_{CC} = 4.5$ V to 5.5 V	0	20	0	20
T_A	Operating free-air temperature	–55	125	–40	85	°C

‡ With supply voltages at or near 2 V, the analog switch on-state resistance becomes very nonlinear. It is recommended that only digital signals be transmitted at these low supply voltages.

NOTE 4: All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to TI application report *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V _{CC}	T _A = 25°C			SN54LV4051A		SN74LV4051A		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
R _{on}	On-state switch resistance	I _T = 2 mA, V _I = V _{CC} or GND, V _{INH} = V _{IL} (see Figure 1)	2.3 V	38	180	225	225			Ω
			3 V	30	150	190	190			
			4.5 V	22	75	100	100			
R _{on(p)}	Peak on-state resistance	I _T = 2 mA, V _I = V _{CC} to GND, V _{INH} = V _{IL}	2.3 V	113	500	600	600			Ω
			3 V	54	180	225	225			
			4.5 V	31	100	125	125			
ΔR _{on}	Difference in on-state resistance between switches	I _T = 2 mA, V _I = V _{CC} to GND, V _{INH} = V _{IL}	2.3 V	2.1	30	40	40			Ω
			3 V	1.4	20	30	30			
			4.5 V	1.3	15	20	20			
I _I	Control input current	V _I = V _{CC} or GND	5.5 V	±0.1		±1	±1	±1	±1	μA
I _{soff}	Off-state switch leakage current	V _I = V _{CC} and V _O = GND, or V _I = GND and V _O = V _{CC} , V _{INH} = V _{IH} (see Figure 2)	5.5V	±0.1		±1	±1	±1	±1	μA
I _{son}	On-state switch leakage current	V _I = V _{CC} or GND, V _{INH} = V _{IL} (see Figure 3)	5.5 V	±0.1		±1	±1	±1	±1	μA
I _{CC}	Supply current	V _I = V _{CC} or GND	5.5 V	±0.1		20	20	20	20	μA
C _{IC}	Control input capacitance	f = 10 MHz	3.3 V	2						pF
C _{IS}	Common terminal capacitance		3.3 V	23.4						pF
C _{OS}	Switch terminal capacitance		3.3 V	5.7						pF
C _T	Feedthrough capacitance		3.3 V	0.5						pF

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switching characteristics over recommended operating free-air temperature range,
 $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$ (unless otherwise noted)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	TA = 25°C			SN54LV4051A		SN74LV4051A		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
tPLH, tPHL	Propagation delay time	COM or Yn	Yn or COM	C _L = 15 pF, (see Figure 4)	1.9	10	16		16	ns	
tPZH, tPZL	Enable delay time	INH	COM or Yn	C _L = 15 pF, (see Figure 5)	6.6	18	23		23	ns	
tPHZ, tPLZ	Disable delay time	INH	COM or Yn	C _L = 15 pF, (see Figure 5)	7.4	18	23		23	ns	
tPLH, tPHL	Propagation delay time	COM or Yn	Yn or COM	C _L = 50 pF, (see Figure 5)	3.8	12	18		18	ns	
tPZH, tPZL	Enable delay time	INH	COM or Yn	C _L = 50 pF, (see Figure 5)	7.8	28	35		35	ns	
tPHZ, tPLZ	Disable delay time	INH	COM or Yn	C _L = 50 pF, (see Figure 5)	11.5	28	35		35	ns	

switching characteristics over recommended operating free-air temperature range,
 $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ (unless otherwise noted)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	TA = 25°C			SN54LV4051A		SN74LV4051A		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
tPLH, tPHL	Propagation delay time	COM or Yn	Yn or COM	C _L = 15 pF, (see Figure 4)	1.2	6	10		10	ns	
tPZH, tPZL	Enable delay time	INH	COM or Yn	C _L = 15 pF, (see Figure 5)	4.7	12	15		15	ns	
tPHZ, tPLZ	Disable delay time	INH	COM or Yn	C _L = 15 pF, (see Figure 5)	5.7	12	15		15	ns	
tPLH, tPHL	Propagation delay time	COM or Yn	Yn or COM	C _L = 50 pF, (see Figure 4)	2.5	9	12		12	ns	
tPZH, tPZL	Enable delay time	INH	COM or Yn	C _L = 50 pF, (see Figure 5)	5.5	20	25		25	ns	
tPHZ, tPLZ	Disable delay time	INH	COM or Yn	C _L = 50 pF, (see Figure 5)	8.8	20	25		25	ns	

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**switching characteristics over recommended operating free-air temperature range,
 $V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$ (unless otherwise noted)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	$T_A = 25^\circ\text{C}$			SN54LV4051A		SN74LV4051A		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t_{PLH} , t_{PHL} Propagation delay time	Propagation delay time	COM or Y_n	Y_n or COM	$C_L = 15 \text{ pF}$, (see Figure 4)	0.6	4	7	7	7	ns	
t_{PZH} , t_{PZL} Enable delay time	Enable delay time	INH	COM or Y_n	$C_L = 15 \text{ pF}$, (see Figure 5)	3.5	8	10	10	10	ns	
t_{PHZ} , t_{PLZ} Disable delay time	Disable delay time	INH	COM or Y_n	$C_L = 15 \text{ pF}$, (see Figure 5)	4.4	8	10	10	10	ns	
t_{PLH} , t_{PHL} Propagation delay time	Propagation delay time	COM or Y_n	Y_n or COM	$C_L = 50 \text{ pF}$, (see Figure 4)	1.5	6	8	8	8	ns	
t_{PZH} , t_{PZL} Enable delay time	Enable delay time	INH	COM or Y_n	$C_L = 50 \text{ pF}$, (see Figure 5)	4	14	18	18	18	ns	
t_{PHZ} , t_{PLZ} Disable delay time	Disable delay time	INH	COM or Y_n	$C_L = 50 \text{ pF}$, (see Figure 5)	6.2	14	18	18	18	ns	

analog switch characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	V_{CC}	$T_A = 25^\circ\text{C}$			UNIT
					MIN	TYP	MAX	
Frequency response (switch on)	COM or Y_n	Yn or COM	$C_L = 50 \text{ pF}$, $R_L = 600 \Omega$, $f_{in} = 1 \text{ MHz}$ (sine wave) (see Note 5 and Figure 6)	2.3 V	20			MHz
				3 V	25			
				4.5 V	35			
Crosstalk (control input to signal output)	INH	COM or Y_n	$C_L = 50 \text{ pF}$, $R_L = 600 \Omega$, $f_{in} = 1 \text{ MHz}$ (square wave) (see Figure 7)	2.3 V	20			mV
				3 V	35			
				4.5 V	60			
Feed-through attenuation (switch off)	COM or Y_n	Yn or COM	$C_L = 50 \text{ pF}$, $R_L = 600 \Omega$, $f_{in} = 1 \text{ MHz}$ (see Note 6 and Figure 8)	2.3 V	–45			dB
				3 V	–45			
				4.5 V	–45			
Sine-wave distortion	COM or Y_n	Yn or COM	$C_L = 50 \text{ pF}$, $R_L = 10 \text{ k}\Omega$, $f_{in} = 1 \text{ kHz}$ (sine wave) (see Figure 9)	$V_I = 2 \text{ V}_{\text{p-p}}$	2.3 V	0.1		
				$V_I = 2.5 \text{ V}_{\text{p-p}}$	3 V	0.1		
				$V_I = 4 \text{ V}_{\text{p-p}}$	4.5 V	0.1		

NOTES: 5. Adjust f_{in} voltage to obtain 0-dBm output. Increase f_{in} frequency until dB meter reads –3 dB.

6. Adjust f_{in} voltage to obtain 0-dBm input.

operating characteristics, $V_{CC} = 3.3 \text{ V}$, $T_A = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS	TYP	UNIT
C_{pd} Power dissipation capacitance	$f = 10 \text{ MHz}$	5.9	pF

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PARAMETER MEASUREMENT INFORMATION

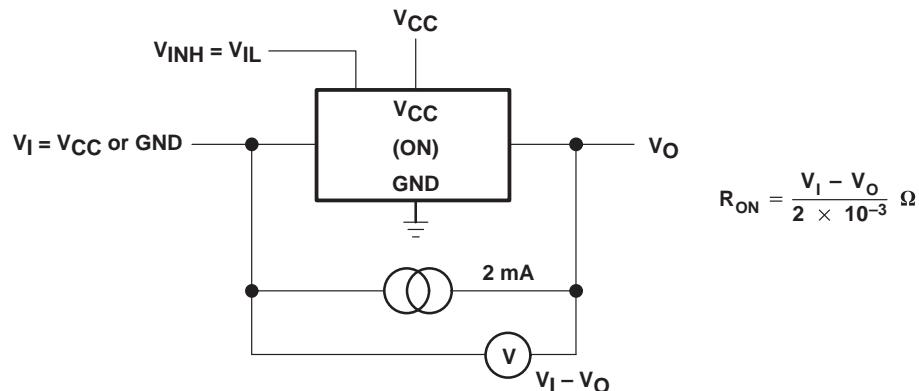


Figure 1. On-State Resistance Test Circuit

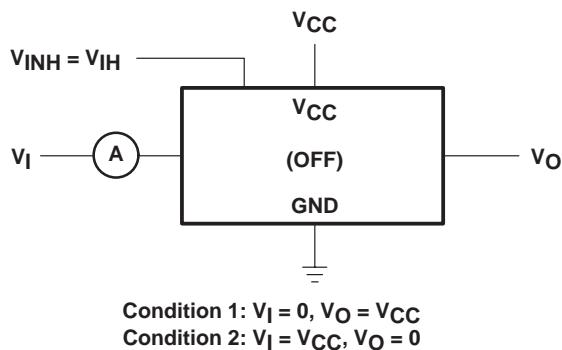


Figure 2. Off-State Switch Leakage-Current Test Circuit

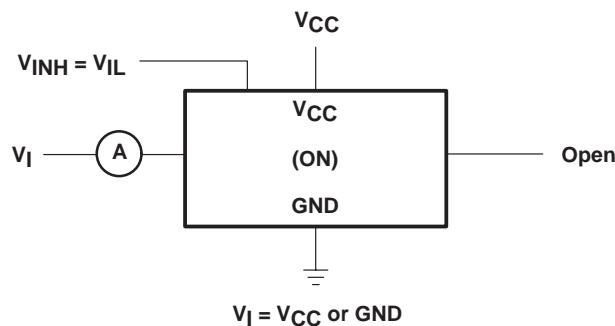


Figure 3. On-State Switch Leakage-Current Test Circuit

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PARAMETER MEASUREMENT INFORMATION

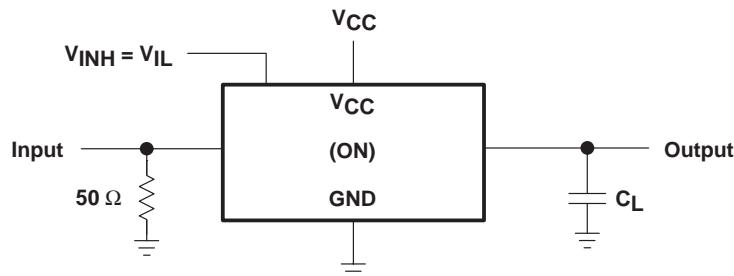


Figure 4. Propagation Delay Time, Signal Input to Signal Output

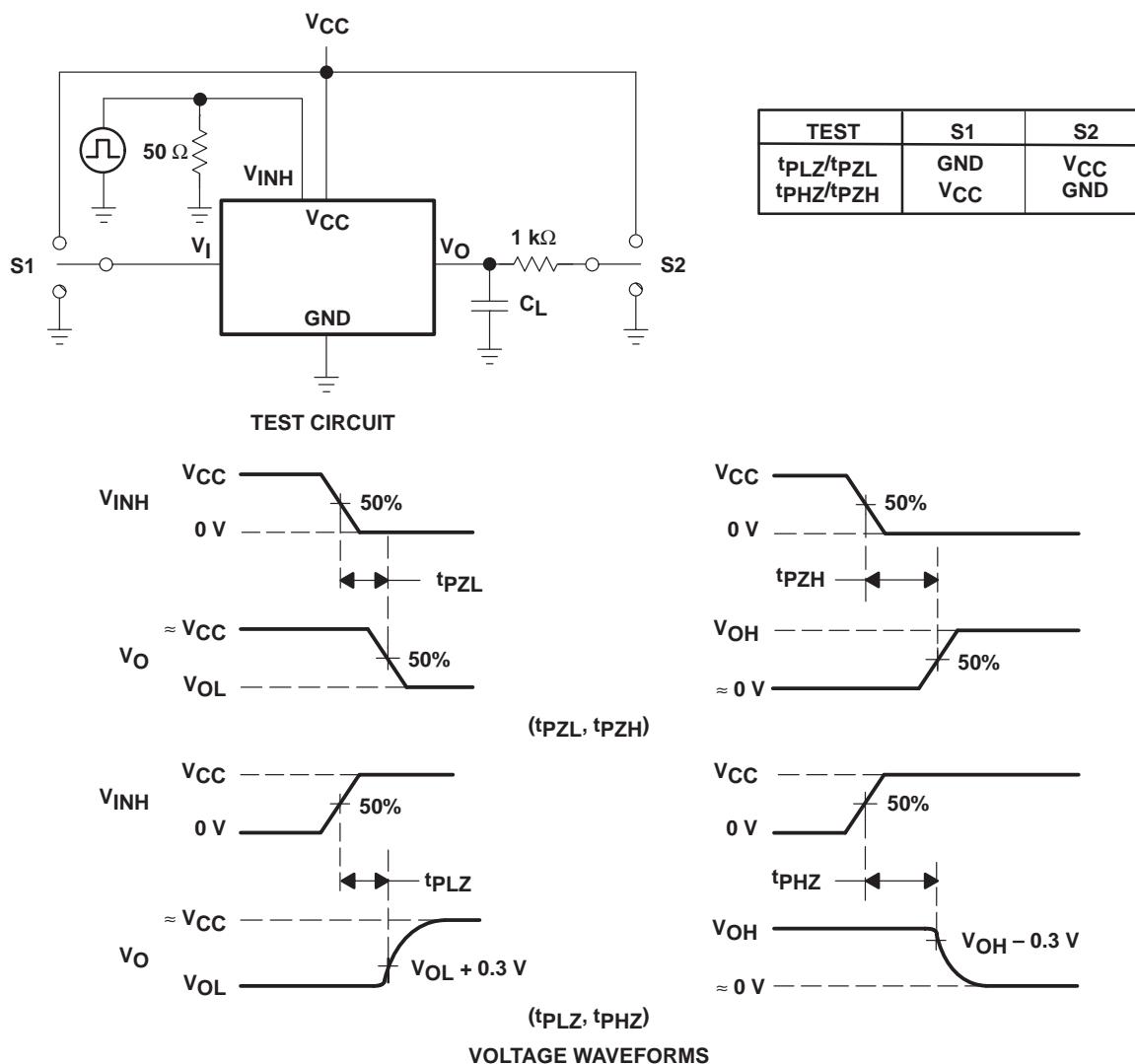
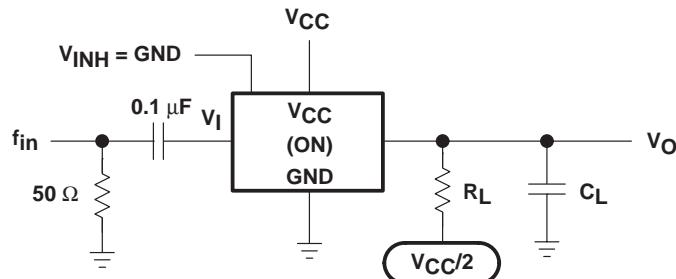


Figure 5. Switching Time (t_{PZL} , t_{PLZ} , t_{ZH} , t_{PHZ}), Control to Signal Output

PARAMETER MEASUREMENT INFORMATION



NOTE A: f_{in} is a sine wave

Figure 6. Frequency Response (Switch On)

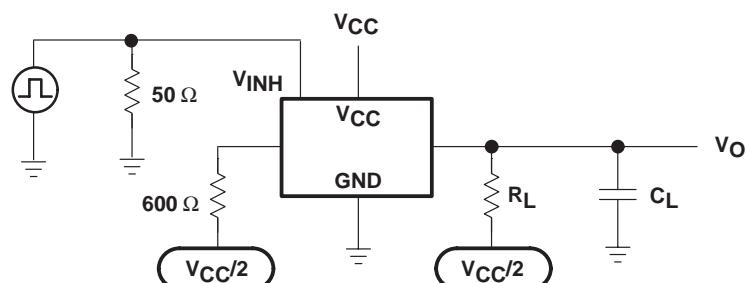


Figure 7. Crosstalk (Control Input, Switch Output)

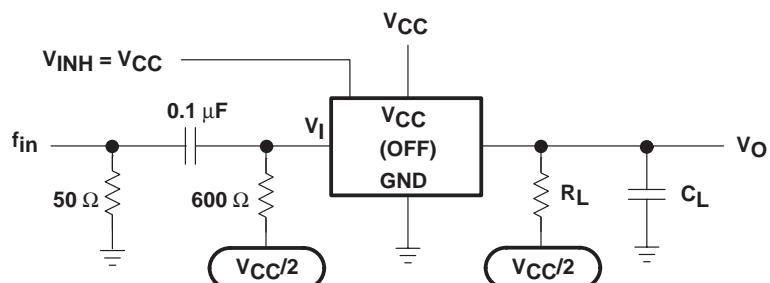


Figure 8. Feedthrough Attenuation (Switch Off)

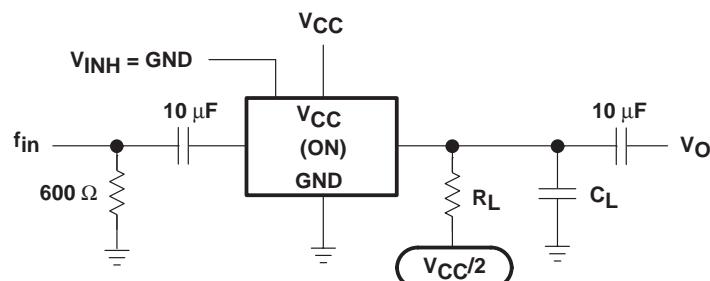


Figure 9. Sine-Wave Distortion

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